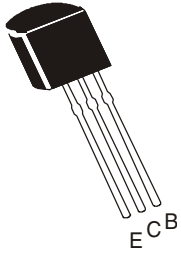


**PNP SILICON PLANAR EPITAXIAL TRANSISTOR**

**CSB1426**

**TO-92  
Plastic Package**



Low Frequency Power Amplifier

**ABSOLUTE MAXIMUM RATINGS (T<sub>a</sub>=25°C unless specified otherwise)**

DESCRIPTION	SYMBOL	VALUE	UNIT
Collector Emitter Voltage	V <sub>CEO</sub>	20	V
Collector Base Voltage	V <sub>CBO</sub>	20	V
Emitter Base Voltage	V <sub>EBO</sub>	6	V
Collector Current	I <sub>C</sub>	3	A
Collector Current Pulse	*I <sub>C</sub>	5	A
Collector Power Dissipation	P <sub>C</sub>	750	mW
Operating And Storage Junction Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	- 55 to +150	°C

\* Single pulse PW=10ms

**ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25°C unless specified otherwise)**

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Collector Base Voltage	V <sub>CBO</sub>	I <sub>C</sub> =50μA, I <sub>E</sub> =0	20			V
Collector Emitter Voltage	V <sub>CEO</sub>	I <sub>C</sub> =1mA, I <sub>B</sub> =0	20			V
Emitter Base Voltage	V <sub>EBO</sub>	I <sub>E</sub> =50μA, I <sub>C</sub> =0	6			V
Collector Cut off Current	I <sub>CBO</sub>	V <sub>CB</sub> =20V, I <sub>E</sub> = 0			100	nA
Emitter Cut off Current	I <sub>EBO</sub>	V <sub>EB</sub> =5V, I <sub>C</sub> = 0			100	nA
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =100mA	82		390	
Collector Emitter Saturation Voltage	**V <sub>CE (sat)</sub>	I <sub>C</sub> =2A, I <sub>B</sub> =0.1A			0.5	V

**DYNAMIC CHARACTERISTICS**

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Transition Frequency	f <sub>T</sub>	I <sub>C</sub> =0.5A, V <sub>CE</sub> =2V, f=100MHz		240		MHz
Output Capacitance	C <sub>ob</sub>	I <sub>E</sub> =0, V <sub>CB</sub> =10V, f=1MHz		35		pF

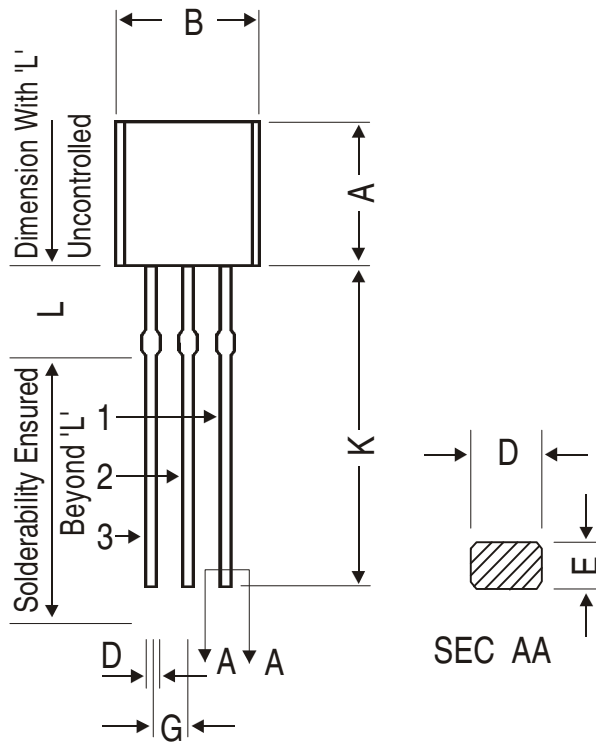
**Classification**

	P	Q	R
h <sub>FE</sub>	82 - 180	120 - 270	180 - 390

\*\*Pulse test

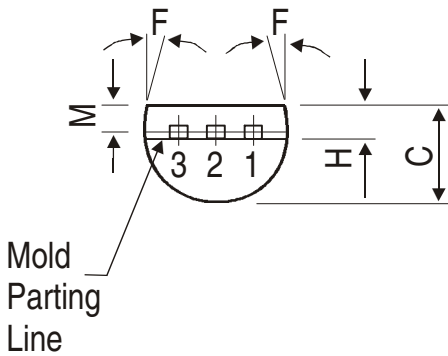
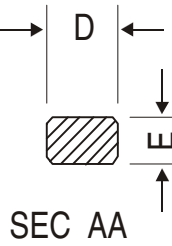
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TO-92 Plastic Package



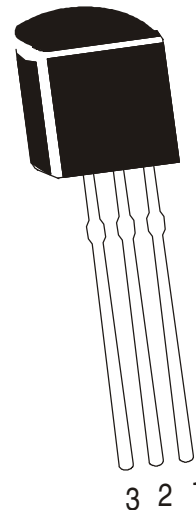
DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.20	1.40
K	12.70	—
L	1.982	2.082
M	1.03	1.20

All dimensions are in mm



PIN CONFIGURATION

1. BASE
2. COLLECTOR
3. EMITTER



The TO-92 Package, Tape and Ammo Pack Drawings are correct as on the date of issue/revision of this Data Sheet.

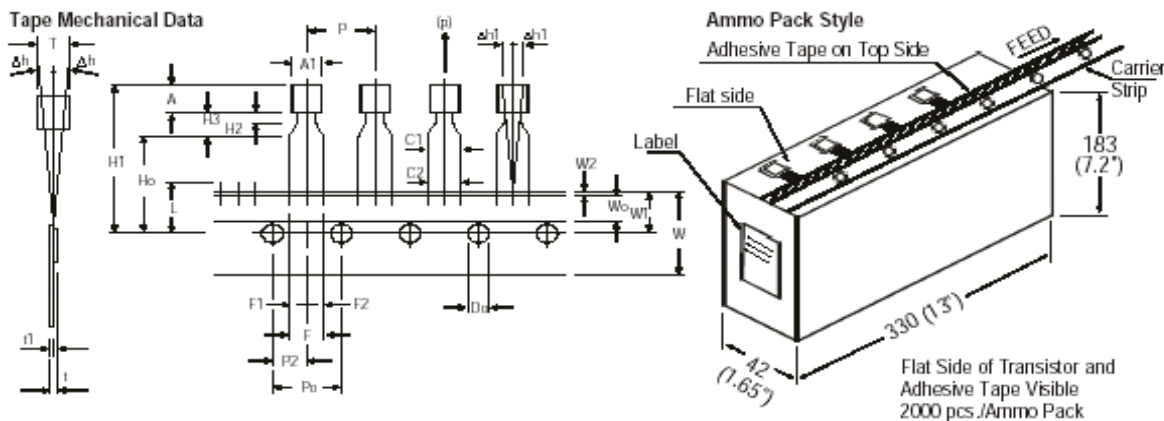
The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

Packing Details

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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## TO-92 Tape and Ammo Pack



All dimensions are in mm

ITEM	SYMBOL	SPECIFICATION			
		MIN.	NOM.	MAX.	TOL.
BODY WIDTH	A1	4.45		5.20	
BODY HEIGHT	A	4.32		5.33	
BODY THICKNESS	T	3.18		4.19	
PITCH OF COMPONENT	P		12.7		$\pm 1.0$
*1 FEED HOLE PITCH	P <sub>0</sub>		12.7		$\pm 0.3$
*2 FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		$\pm 0.4$
DISTANCE BETWEEN OUTER LEADS	F		5.08		+0.6 -0.2
*3 COMPONENT ALIGNMENT SIDE VIEW	$\Delta h$		0	1.0	
*4 COMPONENT ALIGNMENT FRONT VIEW	$\Delta h_1$		0	1.3	
TAPE WIDTH	W		18		$\pm 0.5$
HOLD-DOWN TAPE WIDTH	W <sub>0</sub>		6		$\pm 0.2$
HOLE POSITION	W <sub>1</sub>		9		+0.7 -0.5
HOLD-DOWN TAPE POSITION	W <sub>2</sub>	0.0		0.7	
LEAD WIRE CLINCH HEIGHT	H <sub>0</sub>		16		$\pm 0.5$
COMPONENT HEIGHT	H <sub>1</sub>			24.0	
LENGTH OF SNIPPED LEADS	L			11.0	
FEED HOLE DIAMETER	D <sub>0</sub>		4		$\pm 0.2$
*5 TOTAL TAPE THICKNESS	t			1.2	
LEAD - TO - LEAD DISTANCE	F1, F2	2.40		2.70	-0.1
STAND OFF	H <sub>2</sub>	0.45		1.45	
CLINCH HEIGHT	H <sub>3</sub>			3.0	
LEAD PARALLELISM	C1 - C2			0.22	
PULL - OUT FORCE	(p)		6N		

## NOTES

- Maximum alignment deviation between leads will not to be greater than 0.2mm.
- Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- There will be no more than three (3) consecutive missing components in a tape.
- A tape trailer, having at least three feed holes are provided after the last component in a tape.
- Splices should not interfere with the sprocket feed holes.

## REMARKS

- \*1 Cumulative pitch error 1.0 mm/20 pitch  
 \*2 To be measured at bottom of clinch  
 \*3 At top of body  
 \*4 At top of body  
 \*5 t1 0.3 – 0.6 mm

### **Disclaimer**

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